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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:
Todd O. Bolken

Serial No.: 09/516,080

Filed: March 1, 2000

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APPARATUS

Group Art Unit: 2814

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Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
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37 C.F.R. 1.8

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Michael G. Fletcher
Michael G. Fletcher

Sir:

RESPONSE

In response to the Official Action mailed on April 23, 2003, Applicant respectfully requests reconsideration of the above-identified application in light of the remarks set forth below.

RECEIVED
AUG - I 2003
TECHNOLOGY CENTER 28000